

3.2x1.6mm SMD CHIP LED LAMP

PRELIMINARY SPEC

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE

DEVICES

Part Number: APTR3216VGC/Z

Green

Features

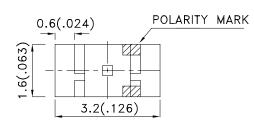
- 3.2mmx1.6mm SMT LED,1.05mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VAVRIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- RoHS COMPLIANT.

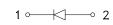
Description

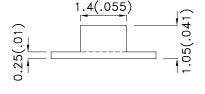
The Green source color devices are made with InGaN Light Emitting Diode.

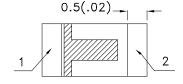
Static electricity and surge damage the LEDS.
It is recommended to use a wrist band or
anti-electrostatic glove when handling the LEDs.
All devices, equipment and machinery must be electrically
grounded.

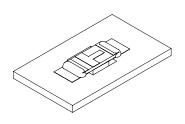
Package Dimensions











Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAH3804 APPROVED: WYNEC REV NO: V.1 CHECKED: Allen Liu DATE: APR/27/2007 DRAWN: Y.L.LI PAGE: 1 OF 5 ERP: 1203006372

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
	7.		Min.	Тур.	201/2
APTR3216VGC/Z	Green (InGaN)	WATER CLEAR	380	800	120°

- Notes: 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	525		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	535		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	39		nm	IF=20mA
С	Capacitance	Green	65		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	3.7	V	IF=20mA
IR	Reverse Current	Green		10	uA	V _R =5V

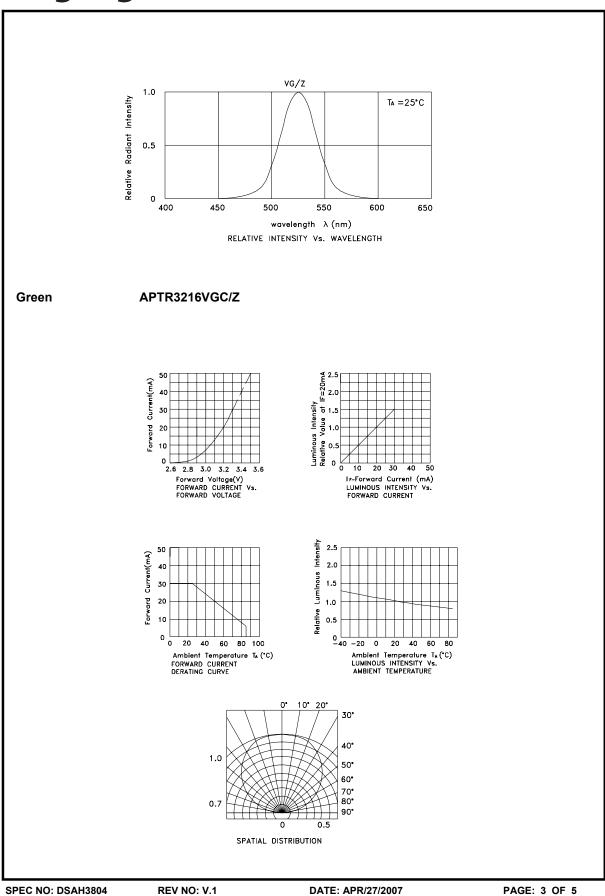
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units	
Power dissipation	111	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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DRAWN: Y.L.LI

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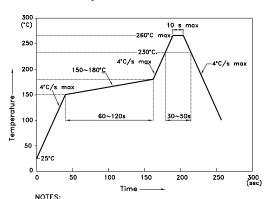
Downloaded from Elcodis.com electronic components distributor

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APTR3216VGC/Z

Reflow Soldering Profile For Lead-free SMT Process.



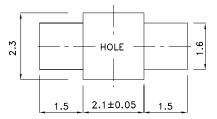
NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

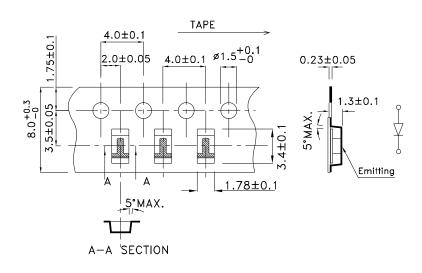
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3. Number of reflow process shall be 2 times or less.

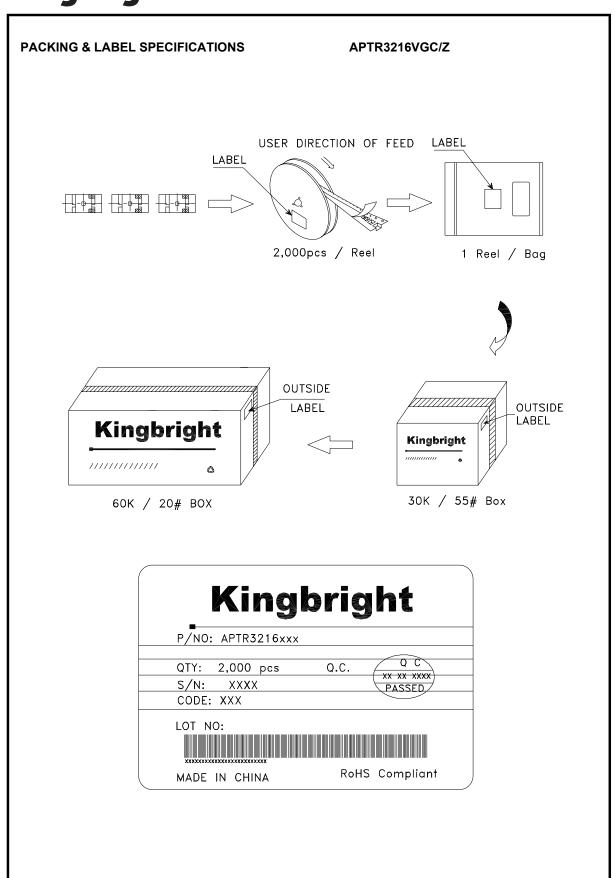
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Specifications (Units: mm)



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